



<b>Form Type</b>	Distribute	<b>Version</b>	2.0	<b>Ref</b>	IPC 1752A	<b>Sectionals</b>	Material Info	<b>Subsectionals</b>	D, A
<b>Supplier Information</b>									
<b>Company Name</b>	TE Connectivity	<b>Request Document ID</b>		<b>Contact Name</b>	Benfer, David W	<b>Contact Title</b>	Prod Compliance Engineer		
<b>Company Unique ID</b>	TE Connectivity	<b>Response Date</b>	2016-02-29	<b>Contact Email</b>	dave.benfer@te.com				
<b>Contact Phone Number</b>	717-986-3725								
<b>Legal Statement</b>									
<b>Supplier Acceptance</b>	true								
<b>Legal Statement</b>									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
<b>Product</b>									
<b>Manufacturer Item number</b>	1734300-1	<b>Amount</b>	20.0	<b>Version</b>	-	<b>Identity</b>			
<b>Manufacturer Item Name</b>	SHIELD FINGER 3025-Z1-T	<b>Weight Uom</b>	mg	<b>Mfr Site</b>		<b>Authority</b>			
<b>Date</b>		<b>UOM</b>	Each						
<b>EUroHS-0508</b>	Product(s) meets EU RoHS requirement without any exemptions								
<b>ChinaRoHS-0508</b>	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
<b>EUREACH-0615</b>	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
<b>Product Disclosure</b>									
<b>Sub-Item/Material/Substance</b>	<b>Level</b>	<b>Name</b>	<b>Substance Category</b>	<b>Substance CAS</b>	<b>Substance Concentration</b>	<b>Quantity</b>	<b>Mass per Unit</b>	<b>UOM</b>	<b>Exemption</b>
Material	1	Gold Plating				1.0	0.8	mg	
Substance	2	Gold	Supplier	7440-57-5	99.7	1.0	0.7976	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.3	1.0	0.0024	mg	
Material	1	Tin Plating				1.0	4.8	mg	
Substance	2	Tin	Supplier	7440-31-5	99.9001	1.0	4.7952	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.0999	1.0	0.0047952	mg	
Material	1	Contact				1.0	14.0	mg	
Substance	2	Titanium	Supplier	7440-32-6	3.3	1.0	0.462	mg	
Substance	2	Copper	Supplier	7440-50-8	96.7	1.0	13.538	mg	
Material	1	Nickel plating				1.0	0.4	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	4.0E-4	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.5	1.0	0.398	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	0.4	1.0	0.0016	mg	